onsemi

MOSFET – Power, N-Channel, SUPERFET III, FRFET

DATA SHEET
www.onsemi.com

650	V,	65	Α,	40	$\mathbf{m}\Omega$
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NTHL040N65S3F

Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

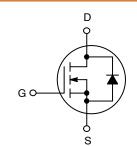
Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 32 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 158 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 1366 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar

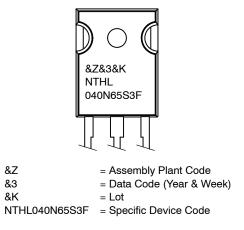
V _{DSS} R _{DS(ON)} MAX		I _D MAX
650 V	40 mΩ @ 10 V	65 A





TO-247 long leads CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		NTHL040N65S3F	Unit
V _{DSS}	Drain to Source Voltage	650	V	
V _{GSS}	Gate to Source Voltage – DC		±30	V
		– AC (f > 1 Hz)	±30	
I _D	Drain Current	– Continuous (T _C = 25°C)	65	А
		– Continuous (T _C = 100°C)	45	
I _{DM}	Drain Current	– Pulsed (Note 1)	162.5	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1009	mJ
I _{AS}	Avalanche Current (Note 2)		9	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		4.46	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
P _D	Power Dissipation	(T _C = 25°C)	446	W
		– Derate Above 25°C	3.57	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 9 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 32.5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	NTHL040N65S3F	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.28	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL040N65S3F	NTHL040N65S3F	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS	•	•			
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	-	-	V
		V_{GS} = 0 V, I_{D} = 1 mA, T_{J} = 150°C	700	-	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 15$ mA, Referenced to $25^{\circ}C$	-	0.63	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	10	μΑ
		V_{DS} = 520 V, T_{C} = 125°C	-	213	-	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30$ V, $V_{DS} = 0$ V	-	-	±100	nA
ON CHARACTE	ERISTICS	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 2.1 \text{ mA}$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 32.5 A	-	32	40	mΩ
9fs	Forward Transconductance	V _{DS} = 20 V, I _D = 32.5 A	-	48	-	S
DYNAMIC CHA	RACTERISTICS	•				
C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	5940	-	pF
C _{oss}	Output Capacitance		-	140	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V}$ to 400 V, $V_{GS} = 0 \text{ V}$	-	1366	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0 \text{ V}$ to 400 V, $V_{GS} = 0 \text{ V}$	-	247	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	158	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	48	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		_	60	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1.1	-	Ω
SWITCHING CH	HARACTERISTICS	•				
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A},$	-	41	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 2.2 \Omega$ (Note 4)	-	41	-	ns
t _{d(off)}	Turn-Off Delay Time		-	101	-	ns
t _f	Turn-Off Fall Time		-	29	-	ns
SOURCE-DRAI	N DIODE CHARACTERISTICS	-				-
۱ _S	Maximum Continuous Source to Drain Diode Forward Current			-	65	А
I _{SM}	Maximum Pulsed Source to Drain Diod	e Forward Current	_	-	162.5	А
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I _{SD} = 32.5 A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 32.5 A,$	_	145	-	ns
		dl _F /dt = 100 Å/µs				

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

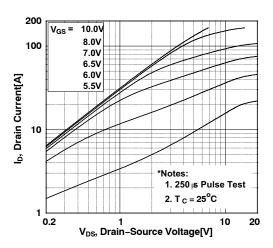
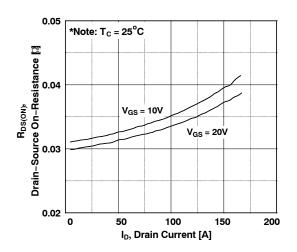
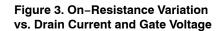
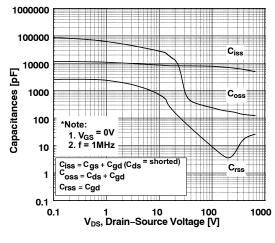


Figure 1. On-Region Characteristics









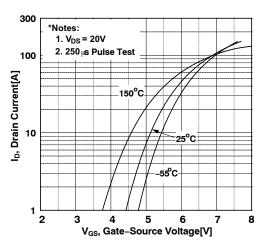


Figure 2. Transfer Characteristics

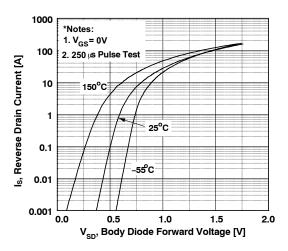
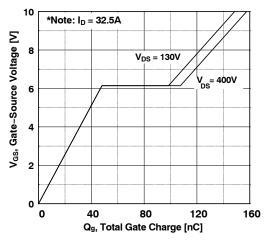


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature





TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

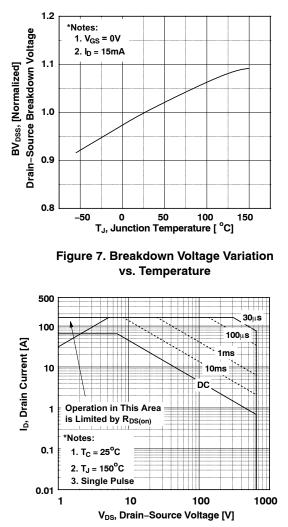
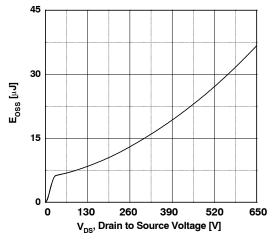
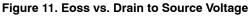
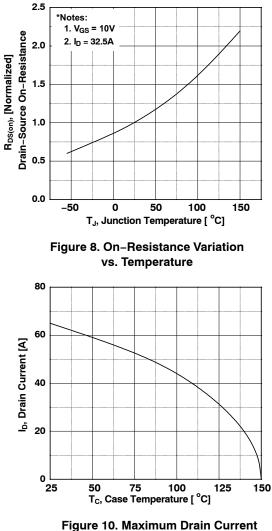


Figure 9. Maximum Safe Operating Area







vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

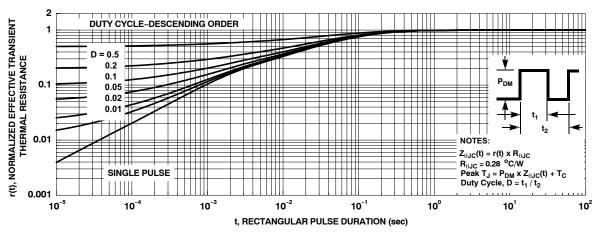
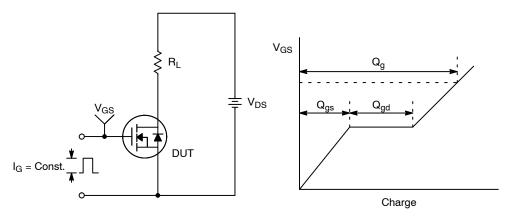


Figure 12. Transient Thermal Response Curve





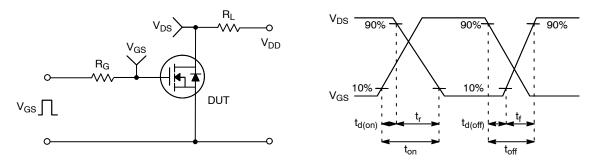


Figure 14. Resistive Switching Test Circuit & Waveforms

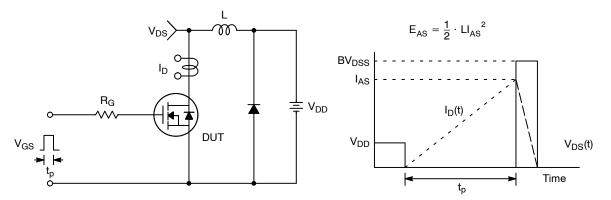


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

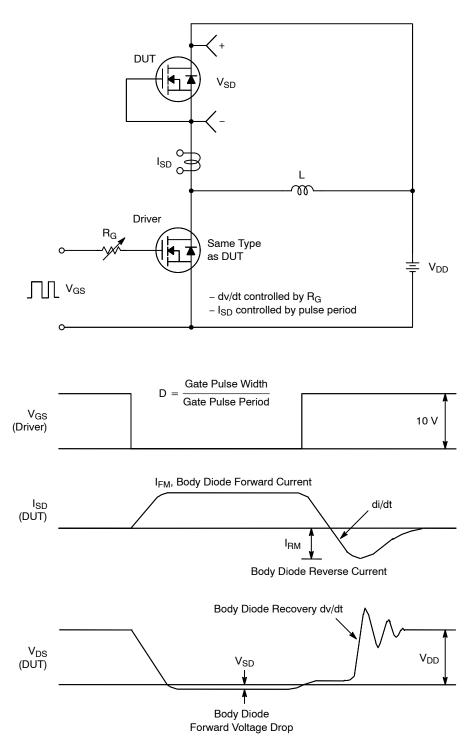


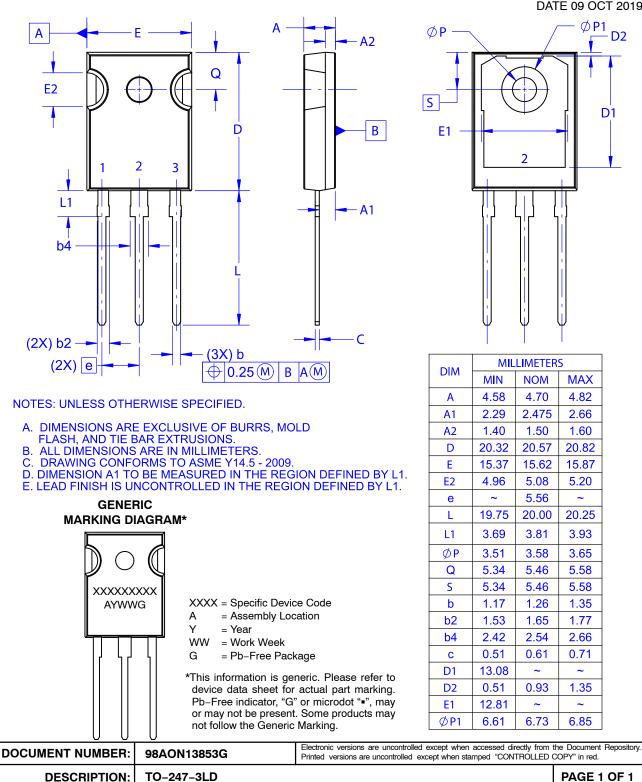
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-247-3LD CASE 340CH **ISSUE A**

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